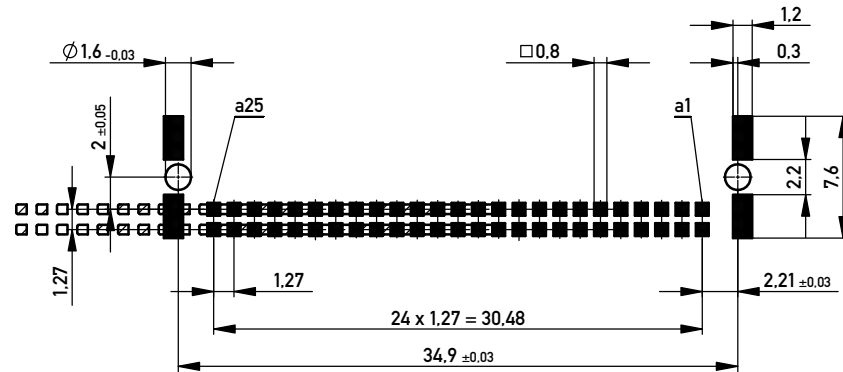


Leiterplatten-Layout Vorschlag für SMT PCB-Layout Proposal for SMT



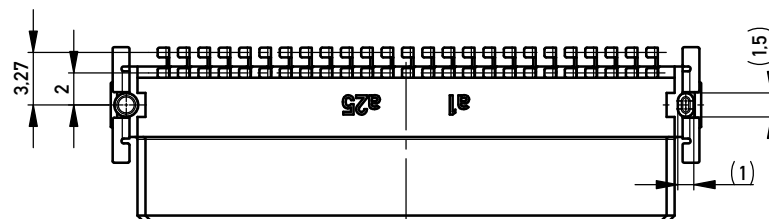
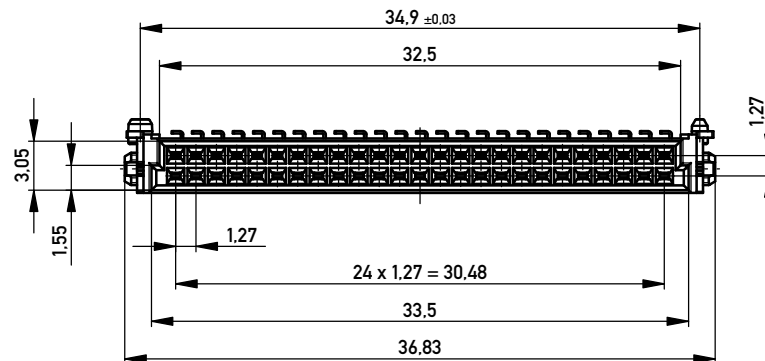
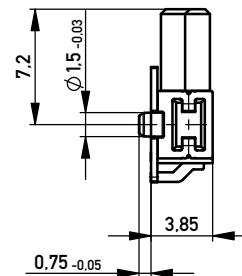
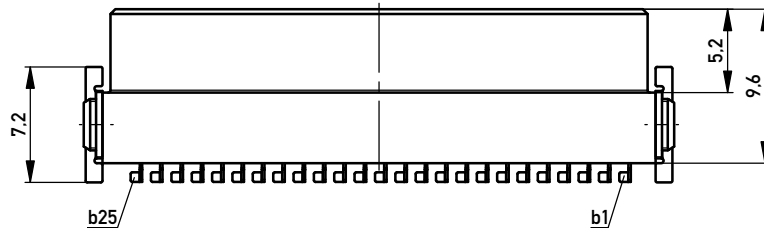
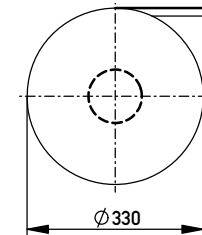
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

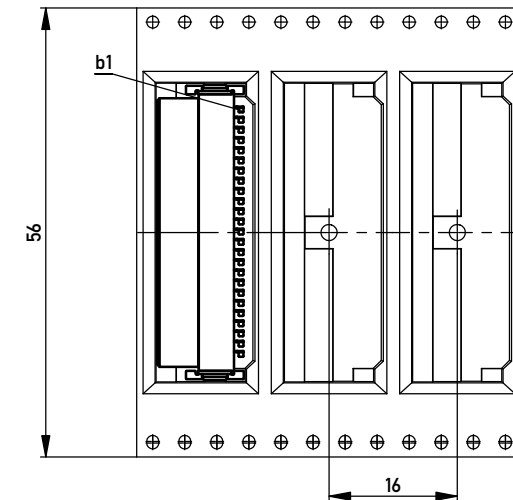
Anschlussbereich verzinkt 4-6 μm
Terminal Area 4-6 μm tin plating

Koplanarität der Anschlüsse $\leq 0.1 \text{ mm}$
Coplanarity Area of Termination $\leq 0.1 \text{ mm}$

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
Packaging unit: 560 pcs



Abspulrichtung - Reel off Direction



BA7-03 - Standard Bauhöhe

type7-03 - Standard Assembly Height

Information:		Tolerances		Scale	3:1
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g		22.04.2014		Federl. SMC-Q 50-SMD-BA7-03	
Index		Date		Female SMC-Q 50-SMD-type7-03	
		ERNI www.ERNI.com		154742	
				I	
				A3	
				Class	
				SMCQ	

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